

November 2013

SGS10N60RUFD 600 V, 10 A Short Circuit Rated IGBT

General Description

Fairchild's RUFD series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUFD series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- 10 A, 600 V, T_C = 100°C
- Low Saturation Voltage: V_{CE}(sat) = 2.2 V @ I_C = 10 A
- High Speed Switching
- High Input Impedance
- · Short Circuit Rating

Applications

Motor Control, UPS, General Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGS10N60RUFD	Unit
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ $T_C = 25^{\circ}C$	16	Α
l _C	Collector Current	@ T _C = 100°C	10	Α
I _{CM (1)}	Pulsed Collector Current		30	Α
	Diode Continuous Forward Current	@ T _C = 25°C	24	Α
I _F	Diode Continuous Forward Current	@ T _C = 100°C	12	Α
I _{FM}	Diode Maximum Forward Current		92	Α
T _{SC}	Short Circuit Withstand Time	@ T _C = 100°C	10	μS
T _{SC} P _D	Maximum Power Dissipation	@ T _C = 25°C	55	W
	Maximum Power Dissipation	@ T _C = 100°C	22	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _J T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for soldering purposes, 1/8" from case for 5 seconds		300	°C

Notes:
(1) Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction-to-Case		2.3	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		3.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions		Тур.	Max.	Unit
Off Chai	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \text{ uA}$	600			V
$\Delta B_{VCES}/$ $\Delta T_{.I}$	Temperature Coeff. of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA		0.6		V/°C
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$			250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$			± 100	nA
On Char	racteristics					
$V_{GE(th)}$	G-E Threshold Voltage	$I_C = 10 \text{ mA}, V_{CE} = V_{GE}$	5.0	6.0	8.5	٧
Vor	Collector to Emitter	$I_C = 10 \text{ A}, V_{GE} = 15 \text{ V}$		2.2	2.8	V
V _{CE(sat)}	Saturation Voltage	$I_C = 16 \text{ A}, V_{GE} = 15 \text{ V}$		2.5		V
Dynami	Characteristics					
C _{ies}	Input Capacitance	V 20 V V 01 V		660		pF
C _{oes}	Output Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$ f = 1 MHz		115		pF
C _{res}	Reverse Transfer Capacitance			25		pF
t _{d(on)}	Turn-On Delay Time			15		ns
t _r	Rise Time	V _{CC} = 300 V, I _C = 10 A,		30		ns
t _{d(off)}	Turn-Off Delay Time			36	50	nS
t _f	Fall Time	$R_G = 20 \Omega, V_{GE} = 15 V,$		158	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		141		μJ
E _{off}	Turn-Off Switching Loss			215		μJ
E _{ts}	Total Switching Loss			356	500	μJ
t _{d(on)}	Turn-On Delay Time			16		ns
t _r	Rise Time			33		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 10 \text{ A},$		42	60	ns
t _f	Fall Time	$R_G = 20 \Omega, V_{GE} = 15 V,$	/	242	350	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		161		μJ
E _{off}	Turn-Off Switching Loss			452		μJ
E _{ts}	Total Switching Loss			613	860	μJ
T _{sc}	Short Circuit Withstand Time	$V_{CC} = 300 \text{ V}, V_{GE} = 15 \text{ V}$ @ $T_C = 100^{\circ}\text{C}$	10			μS
Q_g	Total Gate Charge	$V_{CE} = 300 \text{ V}, I_{C} = 10 \text{ A},$		30	45	nC
Q _{ge}	Gate-Emitter Charge	$V_{GF} = 15 \text{ V}$		5	10	nC
Q_{gc}	Gate-Collector Charge	0_		8	16	nC
Le	Internal Emitter Inductance	Measured 5mm from PKG		7.5		nH

Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{FM}	Diode Forward Voltage	I _F = 12 A	$T_C = 25^{\circ}C$		1.4	1.7	V
		1F = 12 A	T _C = 100°C		1.3		
t _{rr} Dioc	Diode Peak Reverse Recovery		$T_C = 25^{\circ}C$		42	60	ns
			T _C = 100°C		60		115
1		$I_F = 12 \text{ A},$ $di_F/dt = 200 \text{ A/}\mu\text{s}$	$T_C = 25^{\circ}C$		3.5	6.0	Α
'rr			T _C = 100°C	-	5.6		^
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		80	180	nC
			$T_C = 100$ °C	-	220		110

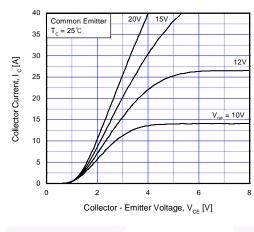


Fig 1. Typical Output Chacracteristics

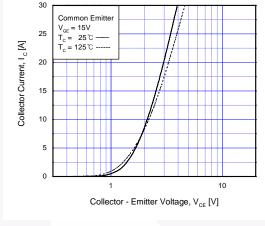


Fig 2. Typical Saturation Voltage Characteristics

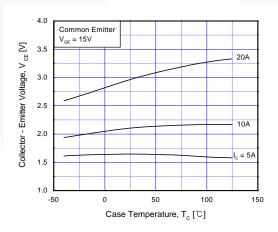


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

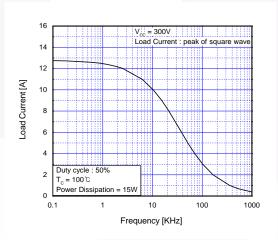


Fig 4. Load Current vs. Frequency

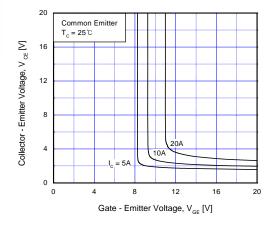


Fig 5. Saturation Voltage vs. V_{GE}

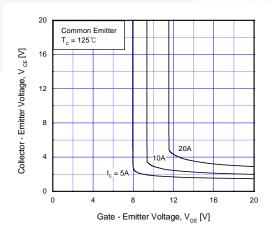
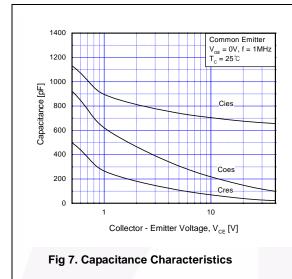
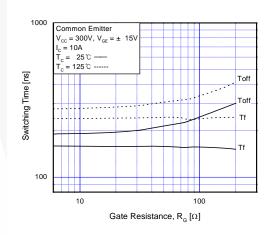


Fig 6. Saturation Voltage vs. V_{GE}



Common Emitter $V_{\rm Cc}=300V, V_{\rm GE}=\pm\ 15V$ $I_{\rm c}=10A$ $I_{\rm c}=25\,{\rm C}$ $I_{\rm c}=125\,{\rm C}$ $I_{$

Fig 8. Turn-On Characteristics vs.
Gate Resistance



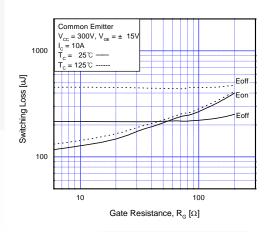
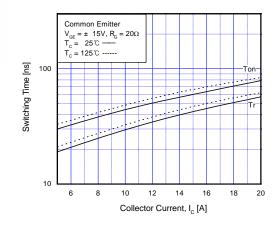


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



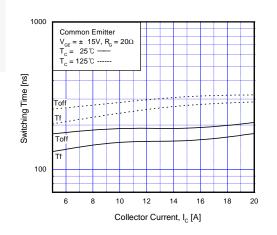
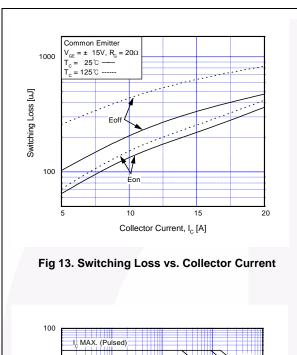


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs.
Collector Current



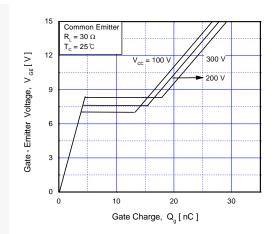
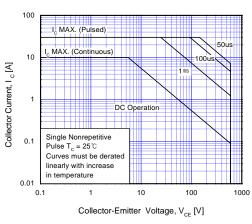


Fig 14. Gate Charge Characteristics



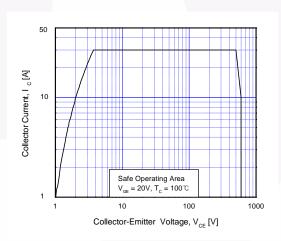


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

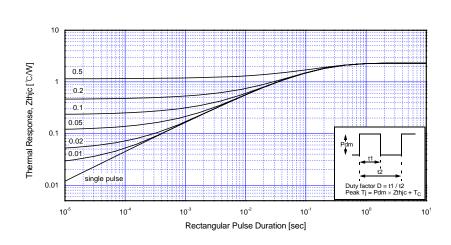
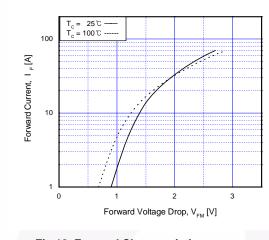


Fig 17. Transient Thermal Impedance of IGBT



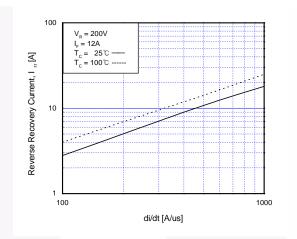
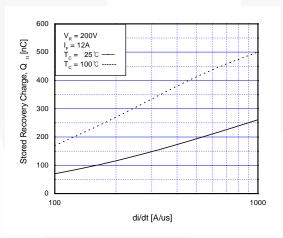


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current



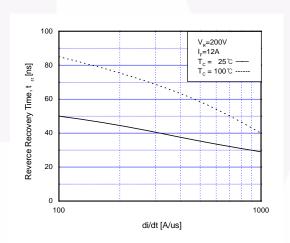


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time

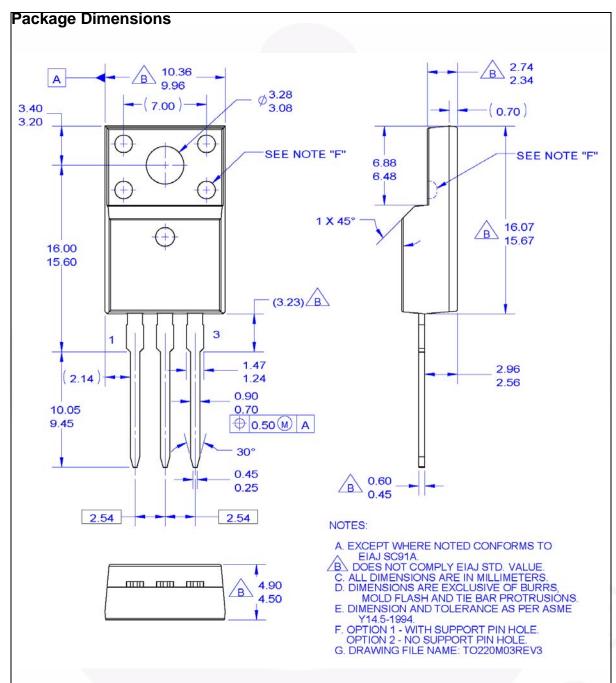


Figure 22. TO-220F 3L - TO220, MOLDED, 3LD, FULL PACK, EIAJ SC91, STRAIGHT LEAD

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF220-003





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ AX-CAF BitSiC™ Build it Now™ CorePLUS™ CorePOWER™

 $CROSSVOLT^{rm}$ CTL™ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK® EfficentMax™ **ESBC™**

Fairchild[®] Fairchild Semiconductor®

FACT Quiet Series™ FACT® FAST[®] FastvCore™ FETBench™ FPS™

F-PFSTM FRFET®

Global Power ResourceSM GreenBridge™

Green FPS™ Green FPS™ e-Series™

 $\mathsf{G} max^\mathsf{TM}$ $\mathsf{G} \mathsf{T} \mathsf{O}^\mathsf{TM}$

IntelliMAX™ ISOPLANAR™

Marking Small Speakers Sound Louder

MegaBuck™ MIČROCOUPLER™ MicroFET^T MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver[®] OptoHiT™ OPTOLOGIC®

OPTOPLANAR®

® PowerTrench® PowerXS™ Programmable Active Droop™ QFĔT

QSTM Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™

STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS[®] SyncFET™

SYSTEM®* **TinyBoost** TinyBuck[®] TinyCalc™ TinyLogic[®] TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™ TRUECURRENT®* μSerDes™

Sync-Lock™

UHC® Ultra FRFET™ UniFET™ **VCXTM** VisualMax™ VoltagePlus™ XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICYFAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 166